

NOT RECOMMENDED FOR NEW DESIGN **USE PDS340**

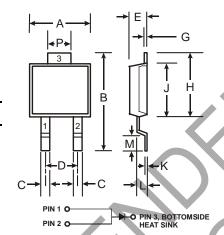
3A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER POWERMITE®3

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant (Note 2)

Mechanical Data

- Case: POWERMITE®3
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish). @3
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.072 grams (approximate)



POWERMITE®3							
Dim	Min	Max					
Α	4.03	4.09					
В	6.40	6.61					
С	.889 NOM 1.83 NOM						
D							
E	1.10	1.14					
G	.178 NOM						
Н	5.01	5.17					
J	4.37	4.43					
K	.178 NOM						
	.71	.77					
M	.36	.46					
P	1.73	1.83					
All Dimensions in mm							

Note:

Pins 1 & 2 must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	٧
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See also Figure 5)	O	3	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load @ $T_C = 100^{\circ}$ C	I _{FSM}	50	А
Typical Thermal Resistance Junction to Soldering Point	$R_{ heta}JS$	3.4	°C/W
Operating Temperature Range	T_J	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

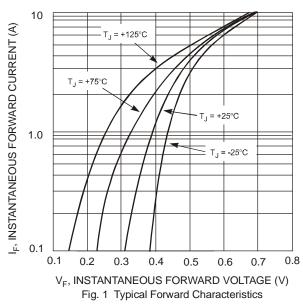
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	40	_		V	$I_R = 0.5 \text{mA}$
Forward Voltage	V_{FM}	_	0.46 0.40 0.57 0.54	0.50 0.44 0.61 0.58		$\begin{split} I_F &= 3A, T_J = 25^{\circ}C \\ I_F &= 3A, T_J = 125^{\circ}C \\ I_F &= 6A, T_J = 25^{\circ}C \\ I_F &= 6A, T_J = 125^{\circ}C \end{split}$
Reverse Current (Note 1)	I _{RM}	_	15 —	500 20	μA mA	$T_J = 25$ °C, $V_R = 40$ V $T_J = 100$ °C, $V_R = 40$ V
Total Capacitance	C _T	_	180	_	pF	f = 1.0MHz, V _R = 4.0V DC

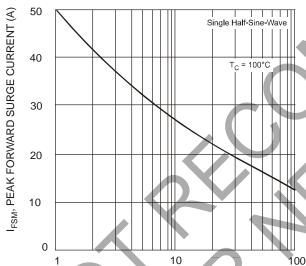
Notes:

- 1. Short duration pulse test used to minimize self-heating effect.
- 2. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.

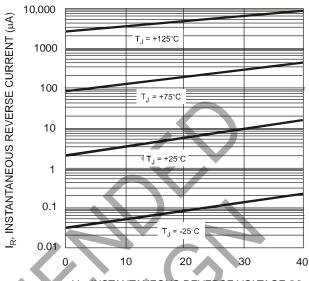


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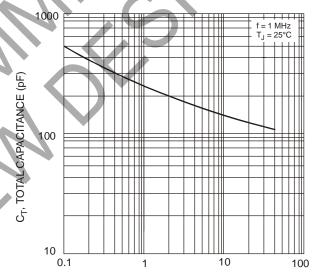




NUMBER OF CYCLES AT 60 Hz
Fig. 3 Max Non-Repetitive Peak Forward Surge Current



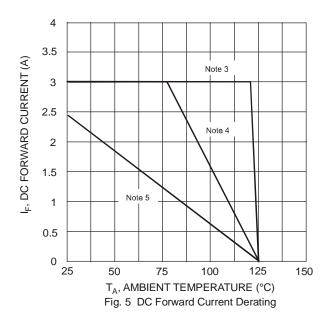
V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics

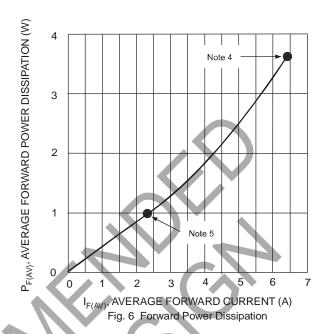


 $\label{eq:VR} {\rm V_R,\,DC\;REVERSE\;VOLTAGE\;(V)}$ Fig. 4 Typical Capacitance vs. Reverse Voltage



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Ordering Information (Note 6)

	 700 100		700 70		
Device	Packagin	g		Shipping	
SBM340-13-F	POWERMIT	E®3		5000/Tape & Reel	_

Notes:

- 3. $T_A = T_{SOLDERING\ POINT}$, $R_{\theta JS} = 3.4^{\circ}\text{C/W}$, $R_{\theta SA} = 0^{\circ}\text{C/W}$. 4. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". $R_{\theta JA} = 1.0^{\circ}\text{C/W}$
- 5. Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R_{0JA} in range of 95-115°C/W.
- 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



SBM340 = Product type marking code D!! = Manufacturers' code marking YYWW = Date code marking YY = Last digit of year (ex: 02 for 2002) WW = Week code (01 to 53) (K) = Factory Designator



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